

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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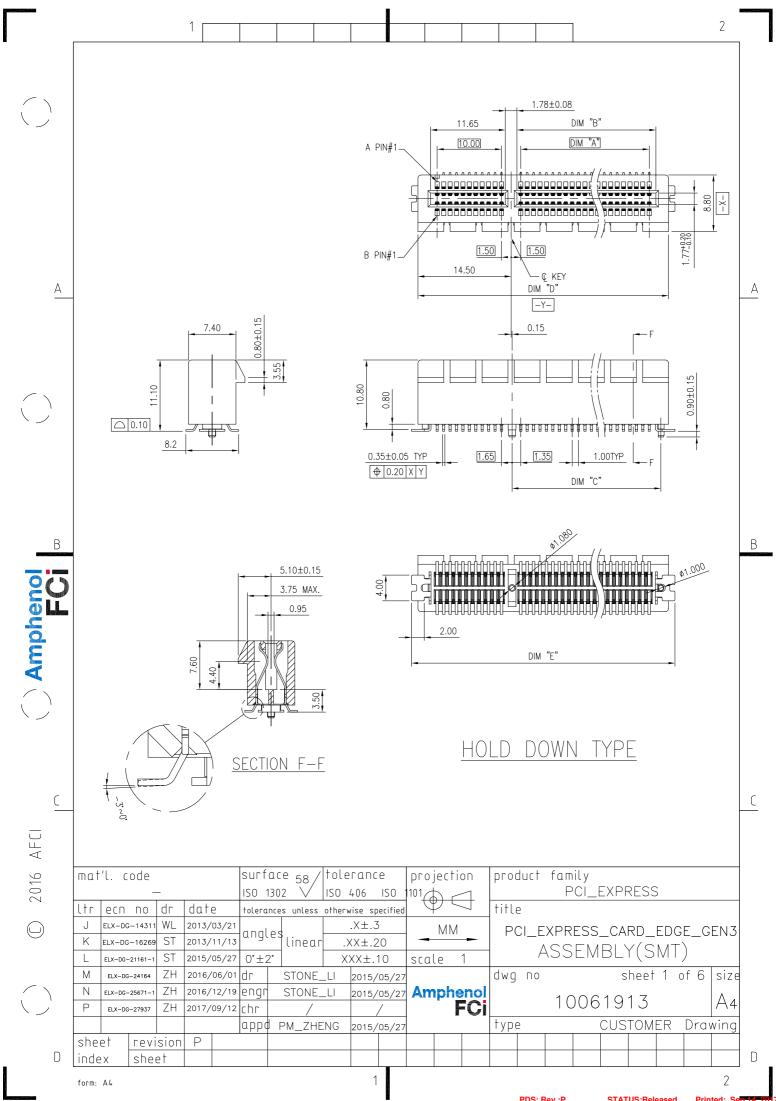
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





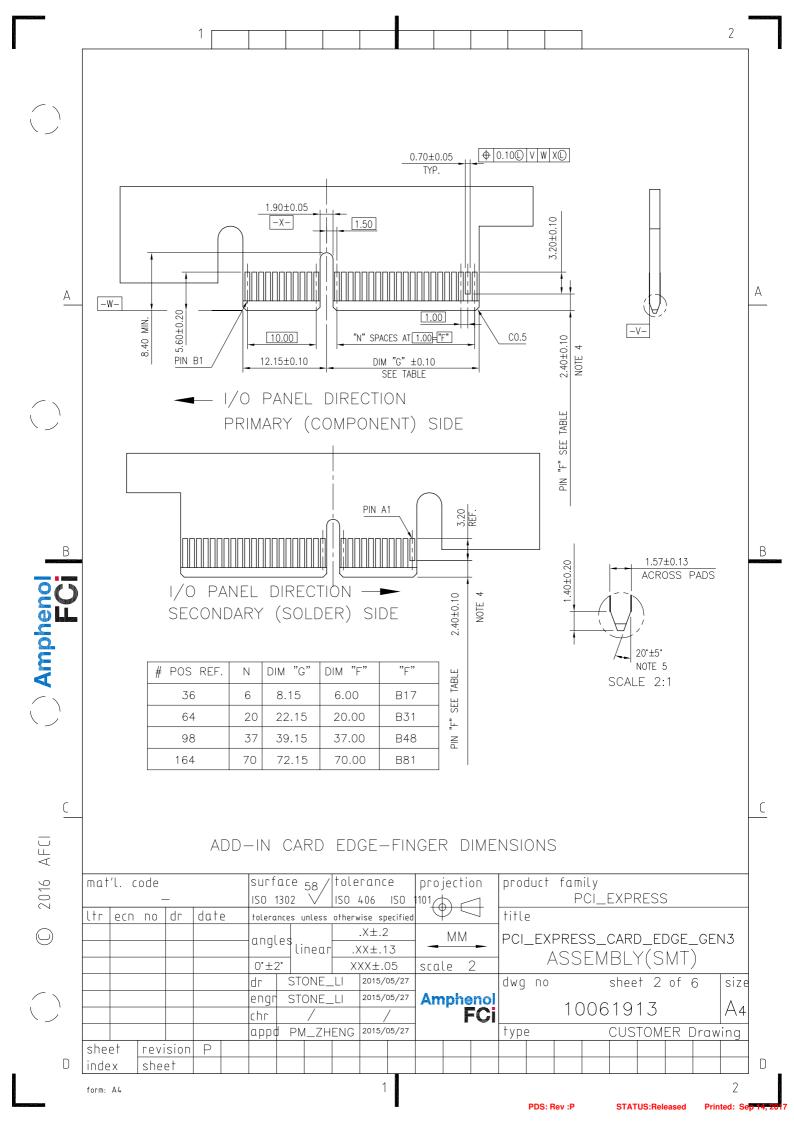


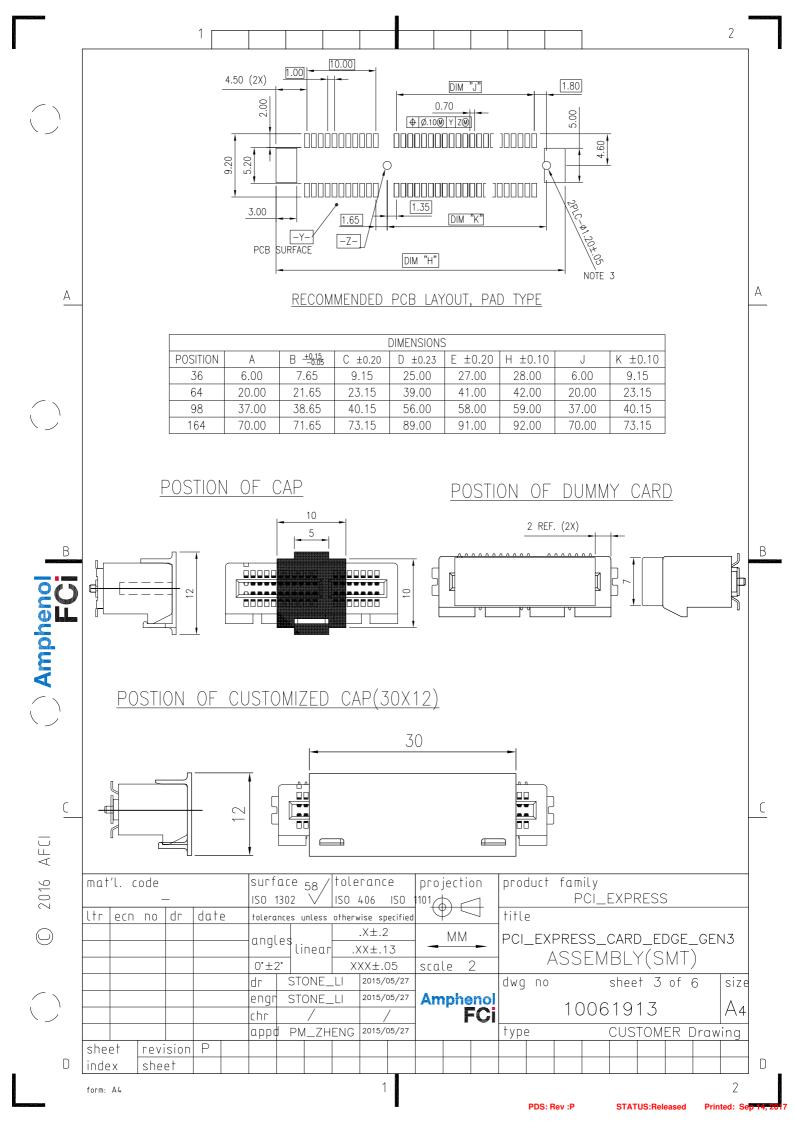


PDS: Rev :P

STATUS:Released

Printed:





1.5±0.5 (2X)

POSTION OF MYLAR

NOTES:

1.MATERIAL:

HOUSING: NYLON, GLASS FILLED UL94V-O RATE, SUITABLE FOR I.R

SOLDERING

TERMINAL: COPPER ALLOY

PLATING: 50u" NICKEL UNDERPLATE ALL OVER
CONTACT AREA PLATING — SEE PRODUCT NUMBER CODE
SOLDER TAIL: TIN 100u" OVER 50u" NICKEL

METAL PADS: COPPER ALLOY FINISH: 100u" TIN OVER 50u" NICKEL

2.PRODUCT SPECIFICATION: GS-12-390

3THE HORIZONTAL AXIS FOR THE PAD PATTERN IS ESTABLISHED BY

A LINE THROUGH THE CENTER OF THE TWO Ø1.0 HOLES.

THE VERTICAL AXIS IS 90° TO THE HORIZONTAL AXIS, THROUGH THE CENTER

OF DATUM -Z-

(4)NO TIE BAR PERMITTED FROM CARD EDGE TO LEADING EDGE OF PAD FOR PINS A1.

(5) CHAMFER EDGES MUST BE FREE OF CUTTING BURRS.

6.RoHS COMPATIBLE PRODUCT SPECIFICATIONS

a - PLATING:

- "LF" MEANS THE PRODUCT IS LEAD-FREE

b - MANUFACTURING PROCESS COMPATIBILITY

THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C±5°C PEAK TEMPERATURE FOR 5 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.

7.A ASYMBOL WILL BE NEXT TO ANY DIMENSION, VIEW, OR NOTE WHICH HAS BEEN MODIFIED WITH CURRENT DRAWING REVISION.

PRODUCT NUMBER CODE

10061913-<u>x x x x x L F</u>

LEAD FREE

PACKAGING OPTIONS

HOUSING COLOR OPTIONS

0-WHITE

1-BLACK

T-TRAY PACKAGING WITHOUT CAP C-TRAY PACKAGING WITH CAP

N-TRAY PACKAGING WITH MYLAR

G-TRAY PACKAGING WITH DUMMY CARD

V-TRAY FOR VACUUM PACKAGING

R-TAPE & REEL PACKAGING WITHOUT CAP OR MYLAR (FOR 36P & 64P ONLY)

P-TAPE & REEL PACKAGING WITH CAP (FOR 36P & 64P& 98P ONLY)

Q-TAPE & REEL PACKAGING WITH CAP (CUSTOMIZED FOR 98P ONLY)

M-TAPE & REEL PACKAGING WITH MYLAR (FOR 36P & 64P & 98P ONLY)

J-TAPE & REEL PACKAGING(24MM PITCH) WITH MYLAR (FOR 98P & 164P ONLY)

U-REEL FOR VACUUM PACKAGING

A-44MM WIDTH TAPE&REEL PACKING WITH MYLAR(FOR 36P ONLY)

Y-HARD TRAY (338x234 FOR 36P, 98P & 164P OPTION ONLY)

Z-HARD TRAY (338x234) WITH MYLAR (FOR 36P, 98P & 164P OPTION ONLY)

B-HARD TRAY (338x234) WITH CAP (FOR 36P, 98P & 164P OPTION ONLY)

H-CUSTOMIZED HARD TRAY (330x235x19.3) WITH 30mm CAP (FOR 98 & 164P ONLY) D-SMALLER HARD TRAY WITH CHAMFER AT LEFT-BOTTOM SIDE (323x136x19)

WITH 30mm CAP (FOR 164P ONLY)

MM

Amphenol

FCi

scale

TERMINAL PLATING OPTIONS

0-50u" Ni UNDERPLATE 30u" Au CONTACT AREA 100u" TIN TAIL AREA ----- COMPATIBLE RoHS

1-50u" Ni UNDERPLATE 15u" Au CONTACT AREA 100u" TIN TAIL AREA ----- COMPATIBLE RoHS

2-50u" Ni UNDERPLATE

GOLD FLASH CONTACT AREA

100u" TIN TAIL AREA ---- COMPATIBLE ROHS

3-50u" NI UNDERPLATE

30u" Au CONTACT AREA

date

mat'l. code

ecn no

dr

GOLD FLASH TAIL AREA ---- COMPATIBLE ROHS

ISO 1302

angles

0°±2°

dr

engi

chr

appd

POS OPTIONS

0 - 36

1 - 64

2 - 983 - 164

surface ₅₈ |tolerance projection 1¹⁰¹+

IS0

ISO 406

 $.X\pm .2$

.XX±.13

XXX±.05

2015/05/27

2015/05/27

2015/05/27

tolerances unless otherwise specified

linear

STONE_LI

STONE_LI

PM_ZHENG

product family PCI_EXPRESS

title

PCI_EXPRESS_CARD_EDGE_GEN3 ASSEMBLY(SMT)

dwg no

sheet 4 of 6 size

10061913

Α4 CUSTOMER Drawina

type

revision

sheet

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PDS: Rev :P

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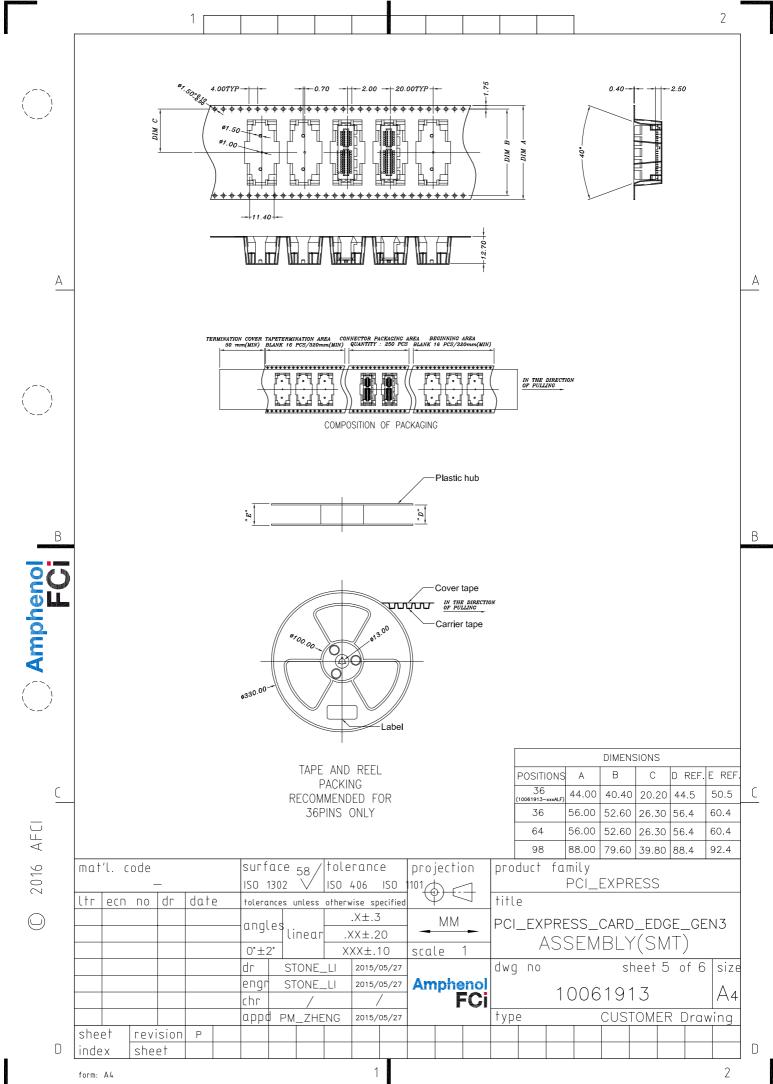
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index form: A4

sheet

STATUS:Released



PDS: Rev :P STATUS:Released

Printed: Sep 14, 2

I For PCI EXPRESS SMT TYPE 36P ONLY.

2. Material:

2.1 Reel:

2.1.1 Plastic hub: High Impact Polystyrene

2.1.2 Cover tape : PE 2.1.3 Carrier tape: ABS 2.2 Waterproof bag: PE 2.3 Desiccative: Silica Gel 2.4 Carton: Corrugated paper

2.5 Baffle : E.P.E

2.6 Angle paperboard: Corrugated paper

3. Dimension:

3.1 Reel:

Α

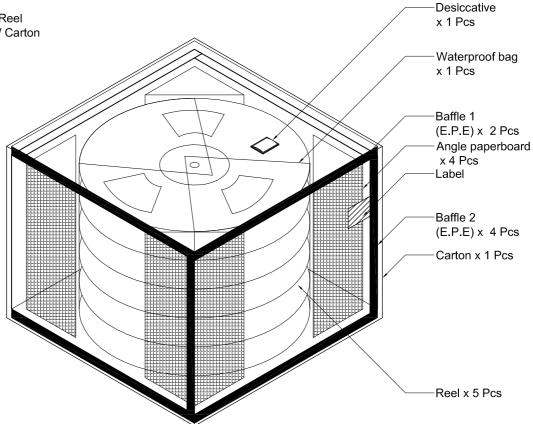
3.1.1 Plastic hub: \emptyset 330 x T50.5 mm 3.1.2 Cover tape : 5690(L) x 37.4(W) mm 3.1.3 Carrier tape : 5640(L) x 44(W)mm 3.2 Waterproof bag : 600(H) x 465(W) x 0.06(T) mm

3.3 Desiccative : 25 gram / Package 3.4 Carton: 380(L) x 380(W) x 300(H) mm 3.5 Baffle (1): 370(L) x 370(W) x 15(H) mm 3.6 Baffle (2): 355(L) x 252(W) x 15(H) mm

3.7 Angle paperboard: 252(H)

4 Quantity: 4.1 250 Pcs / Reel

4.2 1250 Pcs / Carton



PCI_EXPRESS title				
			PCI_EXPRESS_CARD_EDGE_GEN3 ASSEMBLY(SMT)	
6 of 6 s	size			
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/	A4			
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